### DATA SHEET

## MOS FIELD EFFECT TRANSISTOR

# 2SJ449

#### SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

NEC

The 2SJ449 is P-Channel MOS Field Effect Transistor dewww.DataSheet4U.consigned for high voltage switching applications.

#### FEATURES

Low On-Resistance

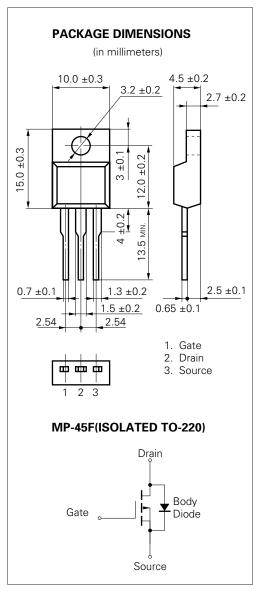
RDS(on) = 0.8  $\Omega$  MAX. (@ VGS = -10 V, ID = -3.0 A)

- Low  $C_{iss}$   $C_{iss} = 1040 \text{ pF TYP}.$
- High Avalanche Capability Ratings
- Isolated TO-220 Package

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	-250	V
Gate to Source Voltage	Vgss	∓30	V
Drain Current (DC)	D(DC)	<b>∓6.0</b>	А
Drain Current (pulse)*	D(pulse)	<b>∓24</b>	А
Total Power Dissipation (T <sub>c</sub> = 25 $^{\circ}$ C)	Ρτι	35	W
Total Power Dissipation (T <sub>A</sub> = 25 $^{\circ}$ C)	Рт2	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current**	las	-6.0	А
Single Avalanche Energy**	Eas	180	mJ
* $P(M \le 10)$ us Duty Cycle $\le 1\%$			

- \* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- \*\* Starting T\_ch = 25 °C, R\_G = 25  $\Omega,$  V\_Gs = –20 V  $\rightarrow$  0

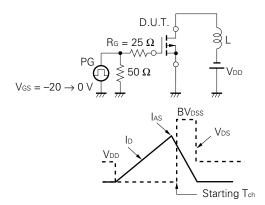


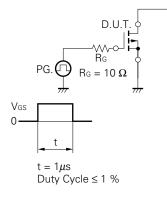
#### ELECTRICAL CHARACTERISTICS (TA = 25 °C)

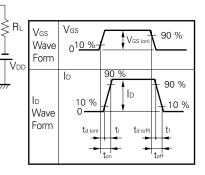
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)		0.55	0.8	Ω	$V_{GS} = -10 \text{ V}, \text{ Id} = -3.0 \text{ A}$
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	-4.0	-4.8	-5.5	V	$V_{DS} = -10 \text{ V}, \text{ ID} = -1 \text{ mA}$
Forward Transfer Admittance	y <sub>fs</sub>	2.0	3.5		S	$V_{DS} = -10 V$ , $I_D = -3.0 A$
Drain Leakage Current	loss			-100	μA	$V_{DS} = -250 \text{ V}, \text{ V}_{GS} = 0$
Gate to Source Leakage Current	Igss			<b>∓100</b>	nA	$V_{GS} = \mp 30 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		1040		pF	$V_{DS} = -10 V$
Output Capacitance	Coss		360		pF	V <sub>GS</sub> = 0
Reverse Transfer Capacitance	Crss		70		pF	f = 1 MHz
ee 4 <b>Turn⊤On Delay Time</b>	td(on)		24		ns	ID = -3.0 A
Rise Time	tr		16		ns	$V_{GS(on)} = -10 V$
Turn-Off Delay Time	td(off)		47		ns	$V_{DD} = -125 V$
Fall Time	tr		14		ns	$R_G = 10 \ \Omega, R_L = 42 \ \Omega$
Total Gate Charge	Q <sub>G</sub>		23.1		nC	ID = -6.0 A
Gate to Source Charge	Q <sub>GS</sub>		7.1		nC	$V_{DD} = -200 V$
Gate to Drain Charge	Qgd		12.9		nC	Vgs = -10 V
Body Diode Forward Voltage	V <sub>F(S-D)</sub>		0.92		V	$I_F = -6.0 \text{ A}, \text{ V}_{GS} = 0$
Reverse Recovery Time	trr		155		ns	$I_F = -6.0 \text{ A}, \text{ V}_{GS} = 0$
Reverse Recovery Charge	Qrr		930		nC	di/dt = 50 A/µs

#### Test Circuit 1 Avalanche Capability

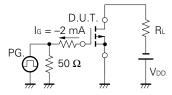
#### Test Circuit 2 Switching Time



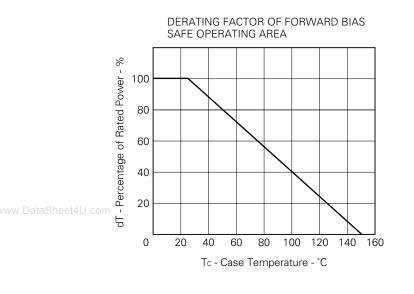




#### Test Circuit 3 Gate Charge

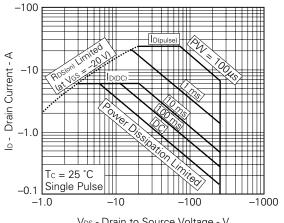


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



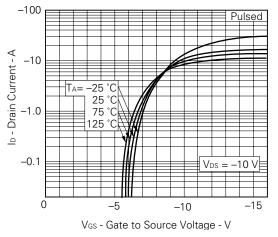
#### TYPICAL CHARACTERISTICS (TA = 25 °C)

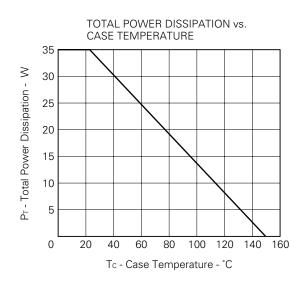




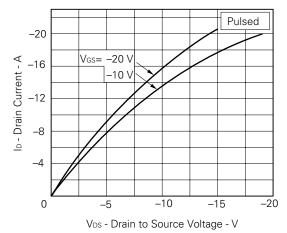
V<sub>DS</sub> - Drain to Source Voltage - V

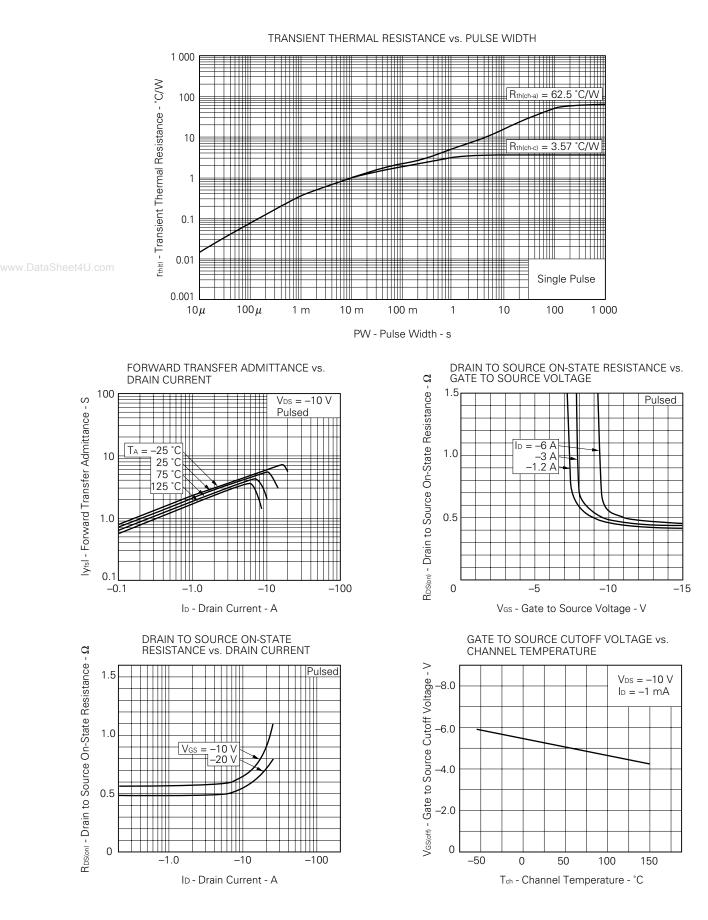
FORWARD TRANSFER CHARACTERISTICS

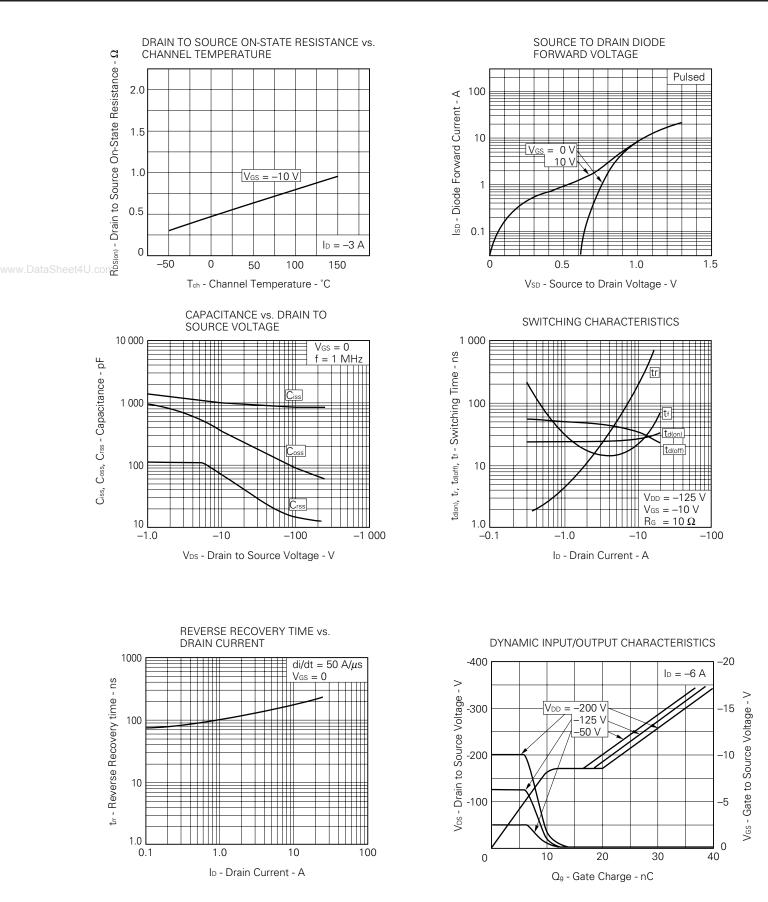


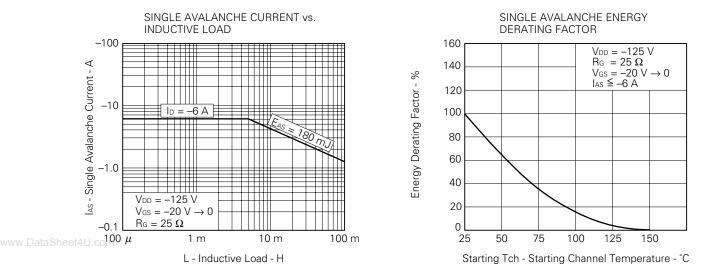


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE









#### REFERENCE

Document Name	Document No.	
NEC semiconductor device reliability/quality control system.	TEI-1202	
Quality grade on NEC semiconductor devices.	IEI-1209	
Semiconductor device mounting technology manual.	IEI-1207	
Semiconductor device package manual.	IEI-1213	
Guide to quality assurance for semiconductor devices.	MEI-1202	
Semiconductor selection guide.	MF-1134	
Power MOS FET features and application switching power supply.	TEA-1034	
Application circuits using Power MOS FET.	TEA-1035	
Safe operating area of Power MOS FET.	TEA-1037	

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.

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